Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an riginal, first and joint inventor (if plural names are listed below) f the subject matter which is claimed and for which a patent is sought in the invention entitled (Inser(Title) COMPATIBILIZING AGENT AND MODERAL COPOLYMERIZABLE UNSATURATED RESIN COMPOSITION. AND MOLDED ARTICLE the specification of which BEST AVAILABLE COPY Qxis attached hereto. 1. (Check on f blocks was filed on 2. 1, 2, or 3. International PCT Application Serial No. See note A and was amended on on back f (if applicable) this pag) 3. was filed on U.S. Application Serial No. and was amended on (if applicable) I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to the examination of this application as defined in Title 37, Code of Federal Regulations, § 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, \$ 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed: Priority Claimed 24/11/1999 X Yes No Patent 11-332664 Japan Ħ (Day/Month/Year Filed) (Country) (List prior (Number) O No f reign (Day/Month/Year Filed) (Country) applications. (Number) See note B ☐ Yes Q No (Day/Month/Year Filed) on back of (Country) (Number) this pag) ☐ Yes (Day/Month/Year Filed) (Country) (Number) (See note C on back See attached list for additional prior foreign applications of this pag) I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Provided States Code, § 120, I acknowledge the duty to disclose material information as defined to the code of Provided States Code, § 120, I acknowledge the duty to disclose the Code of Provided States Code, § 120, I acknowledge the Code of Federal Regulations, § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application: (List Prior U.S. (Status) (patented, pending, abandoned) (Filing Date) (Application Serial Number) Applications) (Status) (patented, pending, abandoned) (Filing Date) (Application Serial Number) And I hereby appoint as principal Attorneys James E. Armstrong, III, Reg. No. 18,366; William F. Westerman, Reg. No. 29,988; Ken-Ichi Hattori, Reg. No. 32,861; John R. Pegan, Reg. No. 18,069; William G. Kratz, Jr., Reg. No. 22,631; Le-Nhung McLeland, Reg. No. 31,541; James P. Welch, Reg. No. 17,379; Ronald F. Naughton, Reg. No. 24,616; Albert Tockman, Roy. No. 19,722; J. Herbert O Toole, Reg. No. 31,404; Mel R. Quintos, Reg. No. 31,898; Michael J. Foycik, Jr., Reg. No. 30,928; Mary E. Gormley, Reg. No. 34,409; James C. Lydon, Reg. N. 30,082; Vivian P. Kafalenos, Reg. No.32,903; Donald W. Hanson, Reg. No. 27,133; Stephen G. Adrian, Reg. No. 32,878; Gregory R. Muir, Reg. No. 35,293; William L. Brooks, Reg. No. 34,129; Joseph J. Zito, Reg. No. 32,076; Stephen B. Parker, Reg. No. P-36,631. ARMSTRONG, WESTERMAN, HATTORI, McLELAND & NAUGHTON 1725 K Street, N.W., Suite 1000 Washington, D.C. 20006 (202) 659-2930 Fax: (202) 887-0357 Please direct all communications to the following address: I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. Takashi Yasumura Full name of sole or first inventor (See note D 2000 November 6. on back of asumura Inventor's signature Date this page) Japan Osaka. Residence Japan Citizenship 3-10-99-107. Tsuruyamadai ... Izumi-shi, Osaka, Post Office Address

Full name of second joint inventor, if any Inventor's signature	November 6, 2000
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